

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	1190	(362/267).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/04/15 16:42
S2	2810	(362/267,800).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/04/20 13:47
S3	1639	(362/800).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/04/15 16:43
S4	194	S2 and (heat or therm\$5).ab.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/15 16:47
S5	128	S4 and @pd<"20030825"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/18 12:40
S6	11	S4 and miniatur\$	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/15 16:56
S7	2810	(362/267,800).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/04/18 12:47
S8	194	S7 and (heat or therm\$5).ab.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 16:07
S9	1874955	S8 and layer or substrate	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/18 12:48
S10	1874955	S8 and layer or substrate	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/18 12:49
S11	1874955	S8 and layer or substrate	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/18 12:50

S12	105	S8 and (layer or substrate)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/18 12:50
S13	58	S8 and (layer or substrate) and @pd<"20030825"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/18 12:56
S14	2810	(362/267,800).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/04/18 12:58
S15	194	S14 and (heat or therm\$5).ab.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/18 12:58
S16	58	S15 and (layer or substrate) and @pd<"20030825"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/18 12:58
S17	38	S16 and (LED or (light adj emitting adj diode)).ab.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/18 12:58
S18	2814	(362/267,800).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/04/19 09:33
S19	195	S18 and (heat or therm\$5).ab.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/19 09:33
S20	58	S19 and (layer or substrate) and @pd<"20030825"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/19 09:33
S21	38	S20 and (LED or (light adj emitting adj diode)).ab.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/19 09:33
S22	0	S21 and (fluid or liquid) and evap\$	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/19 09:37
S23	1	S20 and (fluid or liquid) and evap\$	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/19 09:37

S24	11	"362"/\$.ccls. and (heat or therm\$4) and @pd<"20030825" and (LED or (light adj emitting adj diode)).ab. and (fluid or liquid) and evap\$	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/19 10:56
S25	16	"362"/\$.ccls. and ((heat or therm\$4) adj5 sink) and @pd<"20030825" and (fluid or liquid) and evap\$	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/19 13:17
S26	75	"362"/\$.ccls. and (vapor\$ or evapor\$) and (liquid or fluid) and (heat adj5 sink)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/19 13:40
S27	24	"362"/\$.ccls. and (vapor\$ or evapor\$) and (liquid or fluid) and (heat adj5 sink) and fin	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/19 13:40
S28	14	"362"/\$.ccls. and (vapor\$ or evapor\$) and (liquid or fluid) and (heat adj5 sink) and fin and @pd<"20030825"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/19 16:36
S29	131	"362"/\$.ccls. and (liquid or fluid) and cooling and fins	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/20 08:23
S30	131	"362"/\$.ccls. and (liquid or fluid) and cooling and fins and pd@<"20030825"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/19 17:05
S31	2	"362"/\$.ccls. and (((liquid or fluid) with cooling) and fins).ab.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/20 08:23
S32	1	"362"/\$.ccls. and (cooling near (fluid or liquid) near (vapor\$ or evap\$))	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/20 10:40
S33	104	"362"/\$.ccls. and cooling and (chamber or vessel or container) and (heat adj sink)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/20 11:11
S34	17	((heat adj sink) and chamber and (liquid or fluid) and (vapor\$ or evap\$) and fins).ab.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/20 11:15
S35	17	((heat adj sink) and chamber and (liquid or fluid) and (vapor\$ or evap\$) and fin).ab.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/20 11:15

S36	428	(362/555).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/04/20 13:49
S37	427	S36 and pd@<"20030825"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/20 13:52
S38	24	S36 and pd@<"20030825" and (layer or substrate) and (heat adj sink)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/20 15:59
S39	10457	(257/79-103).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/04/20 16:00
S40	10457	(257/79-103,98,99,100).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/04/20 16:01
S41	10457	(257/79-103,98-100).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/04/20 16:01
S42	3656	S39 and 257/98-100.ccls.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/20 16:02
S43	9983	S39 or 257/98-100.ccls.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/20 16:09
S44	9983	S39 or (257/98-100).ccls.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/20 16:09
S45	9983	(257/79-103).ccls. or (257/98-100). ccls.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 08:36
S46	524	S45 and (heat adj sink)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/20 16:19

S47	6	S45 and 257/796.ccls.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/20 16:20
S48	10669	S45 or 257/796.ccls.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/20 16:20
S49	822	S48 and (heat adj sink)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/20 16:21
S50	822	S48 and (heat adj sink) and pd@<"20030825"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/20 16:21
S51	629	S48 and (heat adj sink) and @pd<"20030825"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/20 16:22
S52	10617	(257/79-103,E27.016).ccls.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 08:50
S53	8447	(257/79-103,E27.016).ccls. and @pd<"20030825"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 08:53
S54	78	S53 and (heat adj sink).ab.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 16:12
S55	364	S53 and (heat adj sink)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 10:14
S56	78	S53 and (heat adj sink).ab. and (heat adj sink)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 10:17
S57	52	S53 and (heat adj sink).ab. and (heat adj sink) and (layer or substrate or wafer)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 10:19
S58	0	(room adj temperature adj silicon). ab. and conduct	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 15:49

S59	24	(room adj temperature adj silicon). ab.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 15:49
S60	0	(room adj temperature adj silicon and ceramic).ab.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 15:49
S61	0	(room adj temperature adj silicon). ab. and conduct	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 15:50
S62	8	(room adj temperature adj silicon). ab. and thermal	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 15:51
S63	104	((room adj temperature adj silicon) or Rtv).ab. and thermal	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 15:52
S64	606	((room adj temperature adj vulcaniz\$) or RTv and silicon).ab.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 15:53
S65	91	((room adj temperature adj vulcaniz\$) or RTv and silicon).ab. and thermal	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 15:54
S66	8	S65 and conduction	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 15:54
S67	2814	(362/267,800).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/04/21 16:08
S68	195	S67 and (heat or therm\$5).ab.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 16:08
S69	36	S68 and silicon	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 16:11
S70	0	S68 and (silicon near conduct)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 16:11

S71	0	S68 and (silicon near thermal)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 16:11
S72	8447	(257/79-103,E27.016).ccls. and @pd<"20030825"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 16:13
S73	0	S72 and (heat adj sink).ab. and (silicon near conduct)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 16:12
S74	0	S72 and (rtv or room adj temperature adj vulcan\$) near silicon	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/21 16:14
S75	1883	(372/36 or 362/373,345).ccls.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/22 10:27
S76	0	(372/36 and 362/373,345).ccls.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/22 10:27
S77	1495	(372/36 or 362/373,345).ccls. and @pd<"20030825"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/22 10:29
S78	249	S77 and silicon	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/22 10:33
S79	213	S77 and silicon and heat	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/22 10:33
S80	6	S77 and silicon near (heat adj sink)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/22 10:36
S81	44	S77 and silicon with (heat adj sink)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/22 10:42
S82	0	S81 and (RTV or (room adj temperature adj vulcan\$))	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/22 10:59

S83	0	S82 and ceramic	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/22 10:59
S84	22049611	@ad<"20030825"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/26 13:29
S85	3105	S84 and (257/796,715,722,706, 796).ccls.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/26 15:12
S86	0	S84 and S85 and "I3" and adhesive and silicon	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/26 13:35
S87	0	S84 and S85 and "I3" and adhesive\$ and silicon	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/26 13:36
S88	4	S84 and S85 and "I3" and silicon	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/26 13:44
S89	762	S84 and S85 and silicon	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/26 13:46
S90	374	S84 and S85 and silicon and adhesive\$	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/26 13:48
S91	223	S84 and S85 and silicon and adhesive\$ and ceramic	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/26 13:52
S92	74	S84 and S85 and adhesive\$ and (ceramic with silicon)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/26 13:59
S93	6	S84 and S85 and adhesive\$ with (ceramic with silicon)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/26 14:01
S94	8564	S84 and (257/796,712-722,706, 796).ccls.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/26 15:14

S95	574	S84 and (438/122).cccls.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 16:24
S96	6	S93 and S94 and silicon	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/26 15:16
S97	97	S94 and S95 and silicon	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/26 15:31
S98	1999	(S94 or S95) and silicon	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/26 16:24
S99	9	("3585454").URPN.	USPAT	OR	ON	2005/04/26 15:53
S10 0	37	(S94 or S95) and silicon and rtv	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/26 16:25
S10 1	46	(S94 or S95) and silicon\$1 and rtv	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/26 16:25
S10 2	0	jp09296114.pn.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 14:21
S10 3	15465430	jp "09296114".pn.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 14:22
S10 4	15465430	jp "09296114 A2".pn.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 14:22
S10 5	22049767	@ad<"20030825"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 16:25
S10 6	574	S105 and (438/122).cccls.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 16:52
S10 7	37	S106 and (LED or (light adj emitting adj diode))	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 16:54

S10 8	27	S106 and (LED or (light adj emitting adj diode)) and (heat adj sink)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 16:54
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Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	131	(rtv adj silicon\$1).ti.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/30 15:51
L2	258	(rtv or (room adj temeprature adj vulcan\$4)adj silicon\$1).ti.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/30 15:57
L3	2	(rtv or (room adj temeprature adj vulcan\$4)adj silicon\$1).ti. and ((heat adj sink) or therm\$4 adj conduct\$3)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/30 15:58
S1	3346	(362/267,373,294).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/04/30 15:50
S2	1720	S1 and @ad<"20030825"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 14:27
S3	47	S2 and silicon\$1 with ((heat adj sink) or thermal\$2)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 16:01
S4	2	jp-09296114-A\$.did.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 14:31
S5	1	jp-3498823-B\$.did.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 14:36
S6	0	us-2004242762-A\$.did.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 14:37
S7	0	us-2004-854278.did.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 14:37
S8	0	2004-854278.did.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 14:37
S9	0	jp-2003-155286-A.did.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 14:38

S10	7	"854278".ap.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 14:50
S11	3	"155286".ap.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 14:41
S12	1	2003jp-0155286.ap,prai.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 14:53
S13	0	"jp-155286-\$.did"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 14:54
S14	0	"155286.pn"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 14:55
S15	3	"155286".pn.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 14:56
S16	2	jp-2003155286-\$.did.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 15:11
S17	835095	(rtv heat conductive silicone rubber).ti.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 15:04
S18	11095	(rtv heat conductive silicone rubber).ti. and jp.frco.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 15:04
S19	1	(rtv adj heat adj conductive adj silicone adj rubber).ti.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 15:07
S20	3	"130613".pn.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 15:11
S21	0	jp-20043498823-\$.did.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 15:27

S22	2	"09296114"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 15:33
S23	2	"2002146154"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 15:36
S24	9	"6020424"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 15:41
S25	18	"4148135"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 15:42
S26	4	"2004043229"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 15:42
S27	1	2003-643978	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 15:42
S28	11	"643978"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 15:43
S29	3346	(362/267,373,294).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/04/29 16:02
S30	1720	S29 and @ad<"20030825"	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 16:02
S31	0	S30 and silicon\$1 with ((heat adj sink) or thermal\$2) and (rtv or (room adj temperature adj vulcan\$5)) adj silicon\$1	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/04/29 16:02